

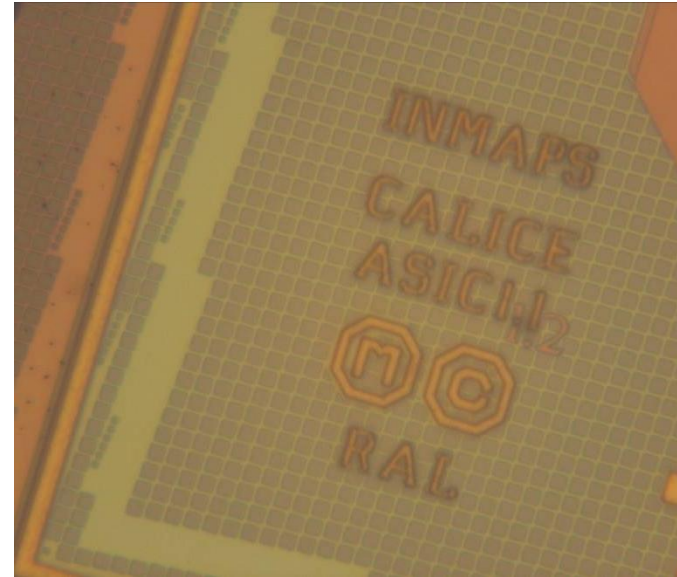
TPAC1.2 Results

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Status

- TPAC1.2 received



WAFERS	EPI	SUBSTRATE	DPW	DICED QTY
3	12	STD	YES	75
3	12	STD	NO	75
3	12	HI RES	YES	75
3	18	HI RES	YES	75

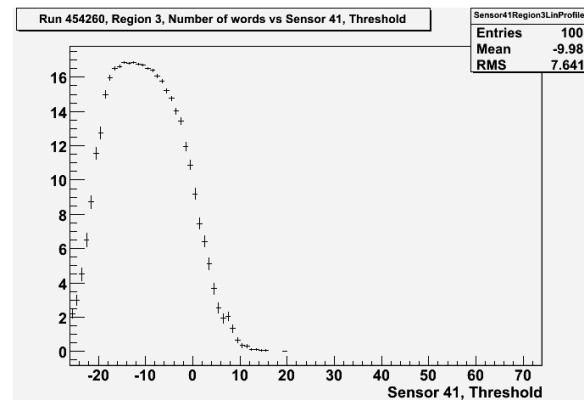
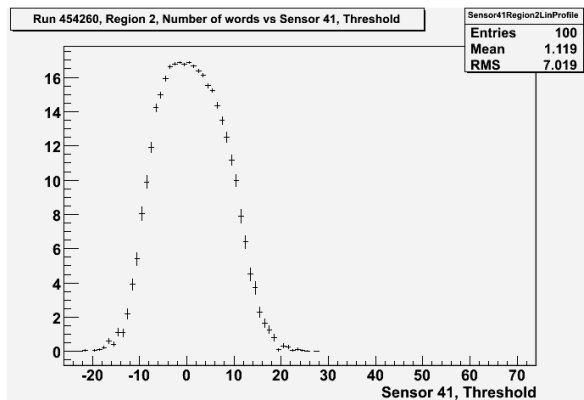
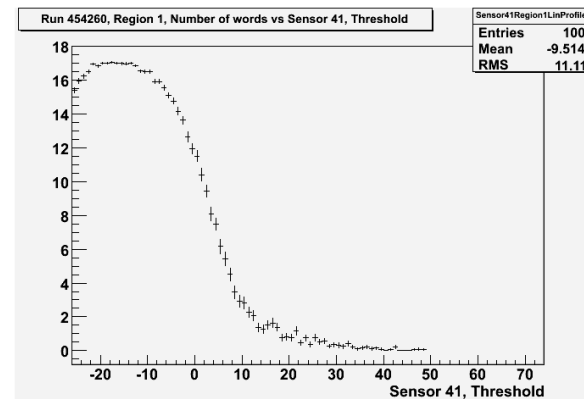
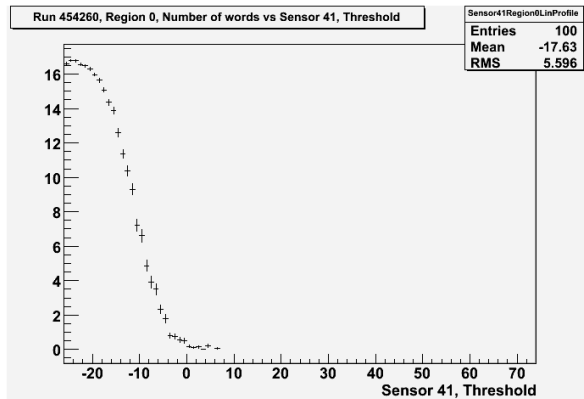
Status

- 7 chips now bonded, 5 more in progress
 - 0 power-ground shorts 😊
 - 5 usable sensors today

PCB	WFR	VARIANT	ALIGNMENT	TEST	NOTES
50	3	12u +DPW	LASER	Configuration errors (all cols)	
29	3	12u +DPW	LASER	Ok	Paul/CALICEDAQ1
43	3	12u +DPW	LASER	Ok	Marcel/55Fe
41	3	12u +DPW	LASER	Ok, with configuration errors (col 53 only)	
21	9	12u HIRES + DPW	LASER	Ok, with configuration errors (col 148 only)	
44	2	12u +DPW	CENTER	Ok	
42	2	12u +DPW	CENTER	Spill fails	
47		12u +DPW	CENTER		
46		12u +DPW	CENTER		
45		12u +DPW	CENTER		
23		12u +DPW	CENTER		
48		18u HIRES + DPW	LASER		

Per-Pixel threshold scans (noise)

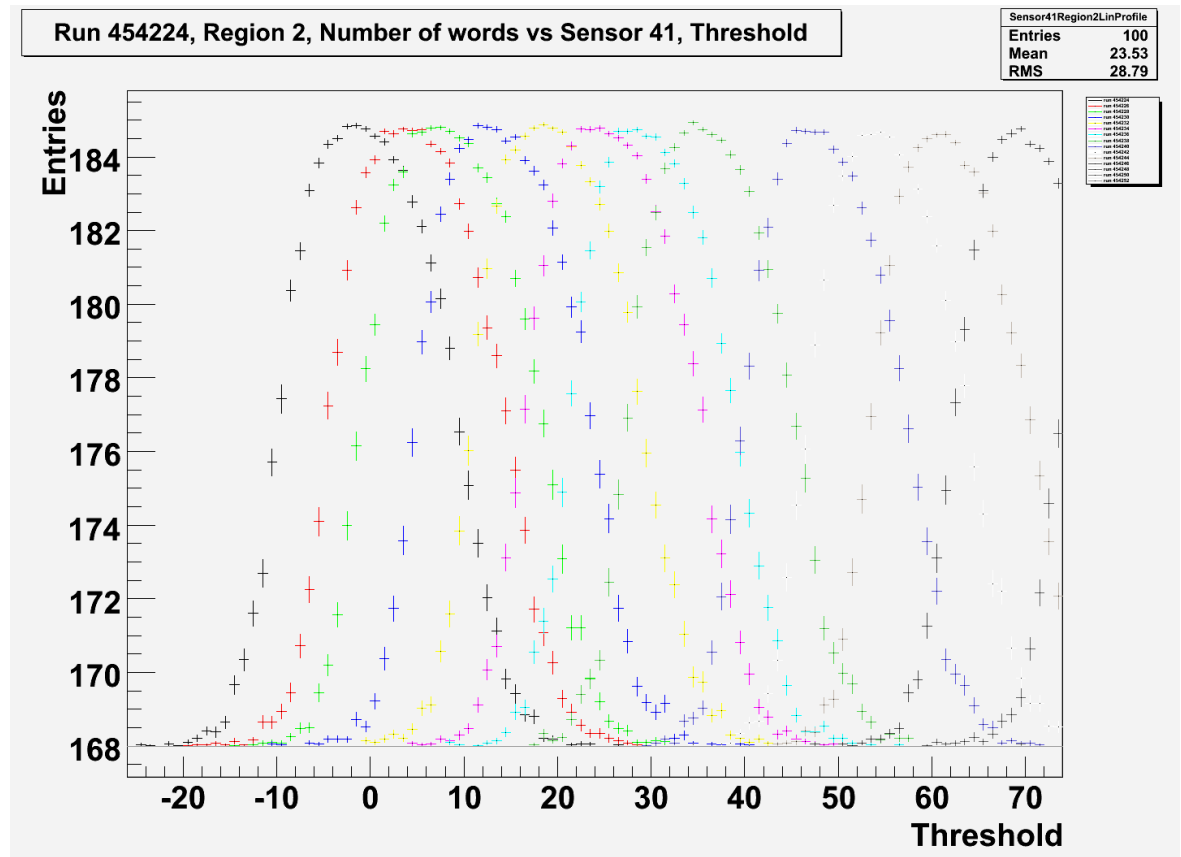
- Randomly selected single pixel in each region
- Noise is **Gaussian** 😊
 - Pixel shielding added on metal 2 appears to help
 - Coupling/oscillation at low thresholds is not evident



Single pixel trim scan

- Trims 0,2,4,6,8,10,12,14,16,18,20,22,24...

- The trim range still needs to be set up correctly
- Was never done for TPAC1.1 which had the larger #bits
- May involve a resistor value change
- Once per-pixel spread is known I can set this
- Sooner the better (for modifying PCBs)
- Currently the range should be twice that on TPAC1.0 with 4x resolution



Pixel addresses (noise)

- TPAC1.1
 - Addressing bug

- TPAC1.2
 - Full addresses restored

